TOSHIBA Photocoupler GaAs Ired & Photo-Triac

TLP560G

Triac Driver
Programmable Controllers
AC-Output Module
Solid State Relay

The TOSHIBA TLP560G consists of a photo–triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 400V(min.)
- On-state current: 100mA(max.)
- Isolation voltage: 2500V_{rms}(min.)
- UL recognized: File No. E67349
- Isolation operating voltage: $2500V_{ac}$ or $300V_{dc}$ for isolation group C^{*1}
- Trigger LED current

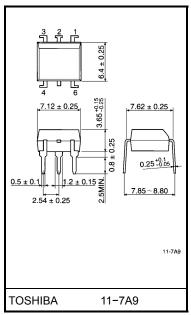
Classi– fication*	Trigger LED	Marking of Classification	
	Min.	Max.	Classification
(IFT5)	_	5	T5
(IFT7)	_	7	T5, T7
Standard	_	10	T5, T7, blank

*Ex. (IFT5); TLP560G(IFT5)
(Note) Application type name for certification test, please use standard product type name, i.e.

TLP560G(IFT5): TLP560G

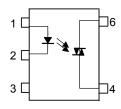
*1: According to VDE0110, table 4.

Unit in mm



Weight: 0.39g (typ.)

Pin Configuration (top view)



1 : Anode

2 : Cathode

3: N.C.

4: Terminal 1

6 : Terminal 2

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit		
	Forward current	I _F	50	mA		
	Forward current derating (Ta ≥	ΔI _F / °C	-0.7	mA / °C		
LED	Peak forward current (100µs pu	I _{FP}	1	Α		
	Reverse voltage	V _R	5	V		
	Junction temperature	Tj	125	°C		
	Off-state output terminal voltage	V_{DRM}	400	V		
	On-state RMS current	Ta = 25°C	IT(D) (O)	100	mA	
_		Ta = 70°C	l _{T(RMS)}	50		
Detector	On-state current derating (Ta ≥	ΔI _T / °C	-1.1	mA / °C		
	Peak on-state current (100µs p	ITP	2	Α		
	Peak nonrepetitive surge currer (Pw = 10ms)	I _{TSM}	1.2	А		
	Junction temperature	Tj	115	°C		
Storage temperature range			T _{stg}	-55 to 125	°C	
Operating temperature range		T _{opr}	-40 to 100	°C		
Lead soldering temperature (10s)		T _{sol}	260	°C		
Isolation voltage (AC, 1min., R.H. ≤ 60%)		BVS	2500	V _{rms}		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{AC}	_	_	120	V _{ac}
Forward current	I _F	15	20	25	mA
Peak on-state current	I _{TP}	_	_	1	Α
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

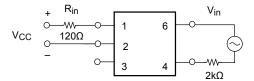
Individual Electrical Characteristics (Ta = 25°C)

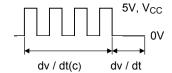
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	V _F	I _F = 10mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1MHz	_	10	_	pF
	Peak off-state current	I _{DRM}	V _{DRM} = 400V	_	10	100	nA
	Peak on-state voltage	V _{TM}	I _{TM} = 100 mA	_	1.7	3.0	V
ctor	Holding current	lΗ	_	_	0.6	_	mA
Detector	Critical rate of rise of off–state voltage	dv / dt	V_{in} = 120 V_{rms} , Ta = 85°C (Fig.	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	$V_{in} = 30V_{rms}$, $I_T = 15mA$ (Fig.	1) –	0.2	_	V / µs

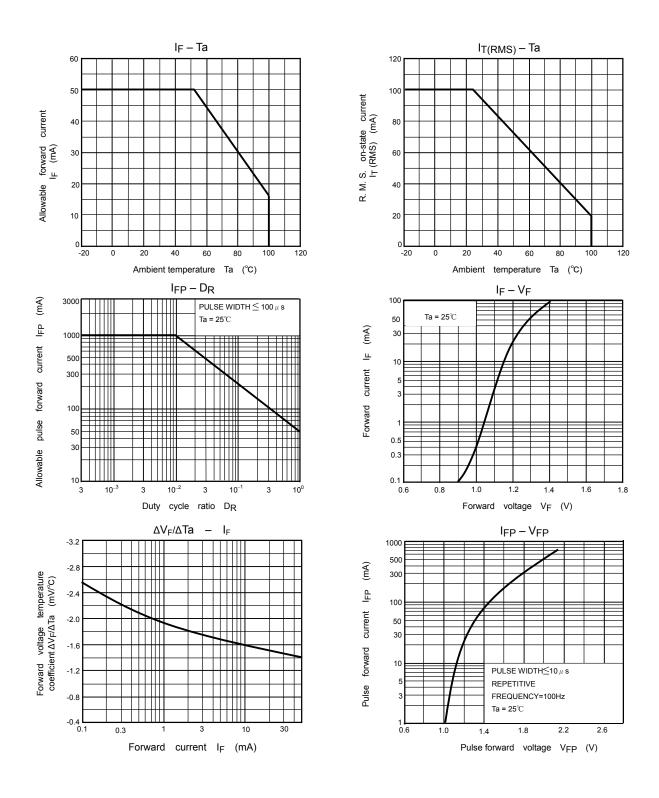
Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	I _{FT}	V _T = 3V	_	5	10	mA
Capacitance (input to output)	Cs	V _S = 0, f = 1MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500V	5×10 ¹⁰	10 ¹⁴	_	Ω
	BV _S	AC, 1 minute	2500	_	_	V
Isolation voltage		AC, 1 second, in oil	_	5000	_	V _{rms}
		DC, 1 minute, in oil	_	5000	_	V_{dc}

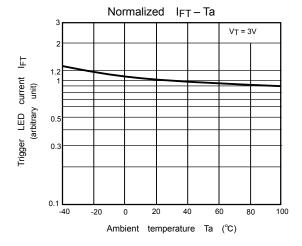
Fig.1: dv / dt test circuit

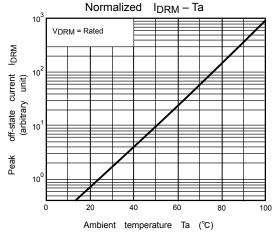


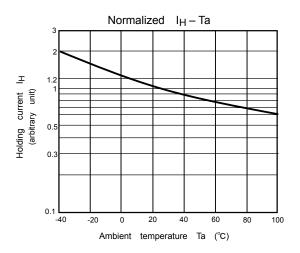


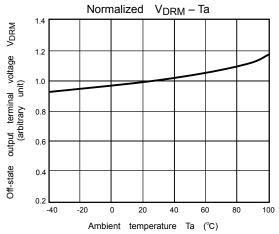


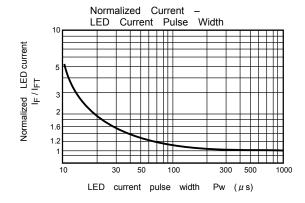
4 2010-10-01











5 2010-10-01

RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information
 in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- Product is intended for use in general electronics applications (e.g., computers, personal equipment, office equipment, measuring equipment, industrial robots and home electronics appliances) or for specific applications as expressly stated in this document. Product is neither intended nor warranted for use in equipment or systems that require extraordinarily high levels of quality and/or reliability and/or a malfunction or failure of which may cause loss of human life, bodily injury, serious property damage or serious public impact ("Unintended Use"). Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. Do not use Product for Unintended Use unless specifically permitted in this document
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
 applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
 FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
 WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
 LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
 LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
 SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
 FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
 limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
 technology products (mass destruction weapons). Product and related software and technology may be controlled under the
 Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product
 or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
 Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances,
 including without limitation, the EU RoHS Directive. TOSHIBA assumes no liability for damages or losses occurring as a result of
 noncompliance with applicable laws and regulations.